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## Dual Common Drain N-Channel PowerTrench<sup>®</sup> MOSFET 20 V, 9.7 A, 16.5 m $\Omega$

#### Features

- Max r<sub>S1S2(on)</sub> = 16.5 mΩ at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 8 A
- Max r<sub>S1S2(on)</sub> = 18 mΩ at V<sub>GS</sub> = 4.2 V, I<sub>D</sub> = 7.4 A
- Max  $r_{S1S2(on)}$  = 21 m $\Omega$  at V<sub>GS</sub> = 3.1 V, I<sub>D</sub> = 7 A
- Max  $r_{S1S2(on)}$  = 24 m $\Omega$  at  $V_{GS}$  = 2.5 V,  $I_D$  = 6.7 A
- Low Profile 0.8 mm maximum in the new package MicroFET 2x3 mm
- HBM ESD protection level > 2 kV (Note 3)
- RoHS Compliant

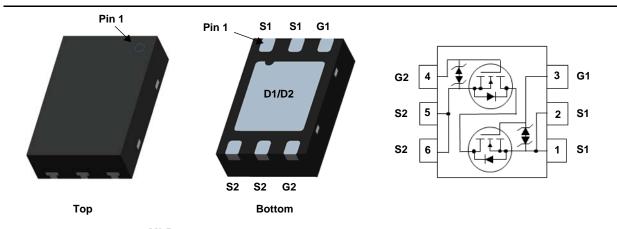


#### **General Description**

This device is designed specifically as a single package solution for Li-Ion battery pack protection circuit and other ultra-portable applications. It features two common drain N-channel MOSFETs, which enables bidirectional current flow, on Fairchild's advanced PowerTrench<sup>®</sup> process with state of the art MicroFET Leadframe, the FDMB2307NZ minimizes both PCB space and r<sub>S1S2(on)</sub>.

#### Application

Li-Ion Battery Pack



MLP 2x3

#### MOSFET Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V <sub>S1S2</sub>	Source1 to Source2 Voltage			20	V
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±12	V
	Source1 to Source2 Current -Continuous	T <sub>A</sub> = 25°C	(Note 1a)	9.7	٨
I <sub>S1S2</sub>	-Pulsed			40	— A
D	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.2	W
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1b)	0.8	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature	Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient(Dual Operation)	(Note 1a)	57	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient(Dual Operation)	(Note 1b)	161	C/W	

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
307	FDMB2307NZ	MLP 2x3	7"	8 mm	3000 units

FDMB2307NZ Dual Common Drain N-Channel PowerTrench®
ual (
Common
Drain
N-Channel
PowerTrench
N <sup>®</sup> MOSFET

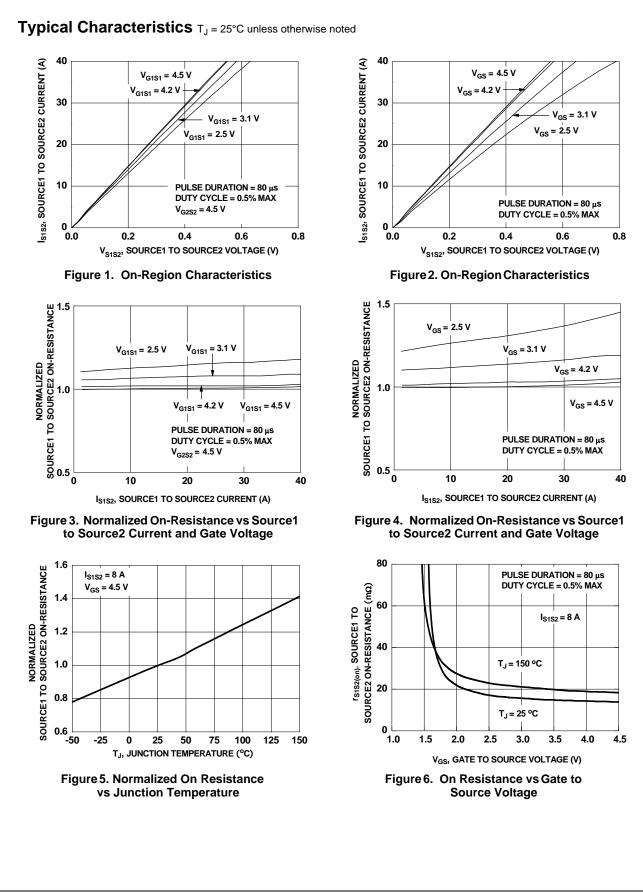
Symbol	Parameter	Test Condi	tions	Min	Тур	Max	Units		
Off Chara	cteristics								
I <sub>S1S2</sub>	Zero Gate Voltage Source1 to Source2 Current	$V_{S1S2} = 16 \text{ V}, V_{GS} =$	0 V			1	μΑ		
I <sub>GSS</sub>	Gate to Source Leakage Current	V <sub>GS</sub> = 12 V, V <sub>S1S2</sub> = 0	D V C			10	μA		
On Chara	cteristics								
		V - V I -	250 4	0.6	1	15	V		
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{S1S2}, I_{S1S2} =$		0.6	1	1.5	V		
		$V_{GS} = 4.5 \text{ V}, \ I_{S1S2} =$		10.5	13.5	16.5	-		
		$V_{GS} = 4.2 \text{ V}, \ I_{S1S2} =$		11	14	18	_		
r <sub>S1S2(on)</sub>	Static Source1 to Source2 On Resistance	$V_{GS} = 3.1 \text{ V}, \ I_{S1S2} =$		11.5	16	21	mΩ		
0102(01)		$V_{GS} = 2.5 \text{ V}, \ I_{S1S2} =$		12	18	24	24		
		$V_{GS} = 4.5 \text{ V}, I_{S1S2} = T_J = 125 \text{ °C}$	8 A,	11	20	29			
9 <sub>FS</sub>	Forward Transconductance	$V_{S1S2} = 5 V, I_{S1S2} =$	8 A		41		S		
	Ok energia tin tin a	5152 5 5152	-						
-	Characteristics				4700	00.40			
C <sub>iss</sub>	Input Capacitance	V <sub>S1S2</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz			1760	2640	pF		
C <sub>oss</sub>	Output Capacitance				229	345	pF		
C <sub>rss</sub>	Reverse Transfer Capacitance				211	320	pF		
R <sub>g</sub>	Gate Resistance (Note 5	)		0.1	2.6	8	Ω		
Switching	g Characteristics								
t <sub>d(on)</sub>	Turn-On Delay Time				12	22	ns		
t <sub>r</sub>	Rise Time	$V_{S1S2}$ = 10 V, $I_{S1S2}$ = 8 A, $V_{GS}$ = 4.5 V, $R_{GEN}$ = 6 Ω			19	34	ns		
t <sub>d(off)</sub>	Turn-Off Delay Time				32	51	ns		
t <sub>f</sub>	Fall Time		t		9.5	17	ns		
, Q <sub>g</sub>	Total Gate Charge	$V_{C1S1} = 0 V \text{ to } 5 V$	1		20	28	nC		
Q <sub>g</sub>	Total Gate Charge	$V_{C1S1} = 0 V \text{ to } 4.5 V$	V <sub>S1S2</sub> = 10V,		18	25	nC		
Q <sub>gs</sub>	Gate1 to Source1 Charge	$V_{G1S1} = 0 V \text{ to } 5 V$ $V_{G1S1} = 0 V \text{ to } 4.5 V$	I <sub>S1S2</sub> = 8 A,		2.8	-	nC		
Q <sub>gd</sub>	Gate1 to Source2 "Miller" Charge	-	$V_{G2S2} = 0 V$		5.3		nC		
					0.0				
Source1-	Source2 Diode Characteristics								
I <sub>fss</sub>	Maximum Continuous Source1-Source2 Die					8	A		
V <sub>fss</sub>	Source1 to Source2 Diode Forward Voltage	$V_{G1S 1} = 0 V, V_{G2S2} = 4.5 V,$ $I_{fss} = 8 A$ (Note 2)			0.8	1.2	V		
NOTES: 1. R <sub>0JA</sub> is determ the user's boa	ined with the device mounted on a 1 in <sup>2</sup> pad 2 oz copper pad rd design. a. 57 °C/W when mounted or a 1 in <sup>2</sup> pad of 2 oz copper		b. 16	i1 °C/W whe	ny design whil	on	termined b		

2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

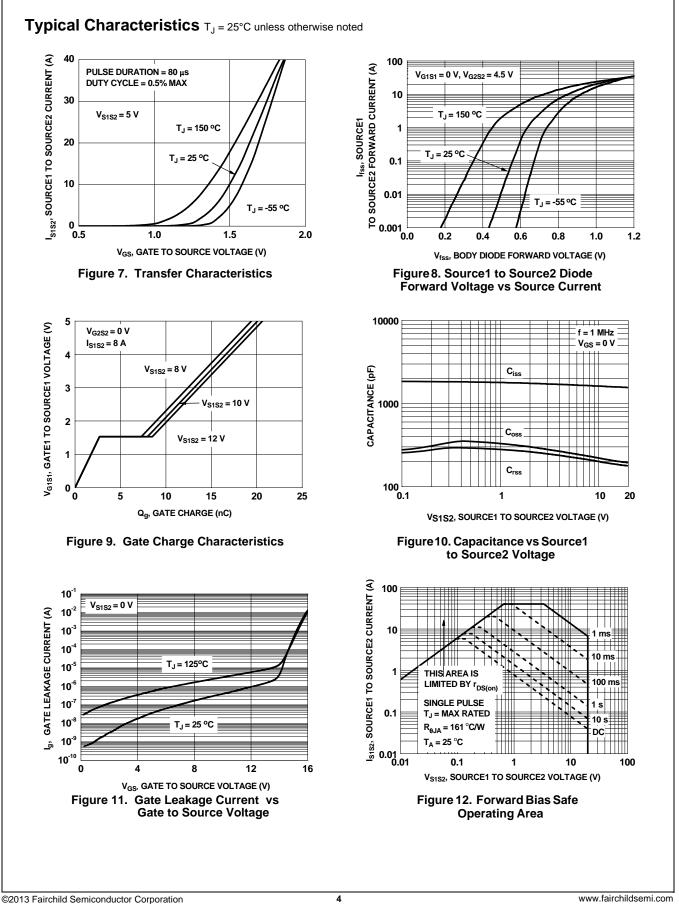
3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse ocurrence only. No continuous rating is implied.

5. Rg is measured on 100% of the die at wafer level.



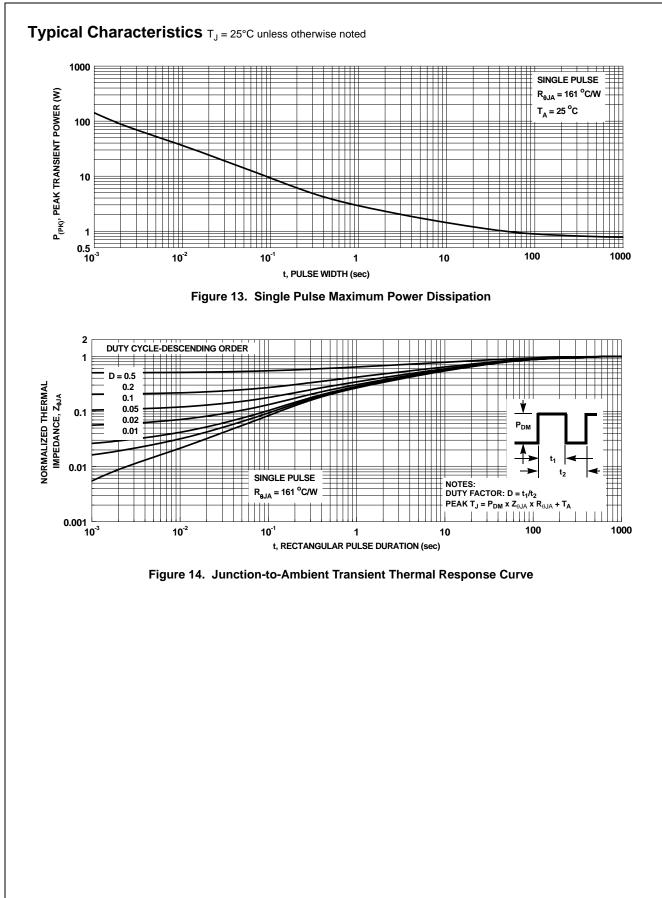
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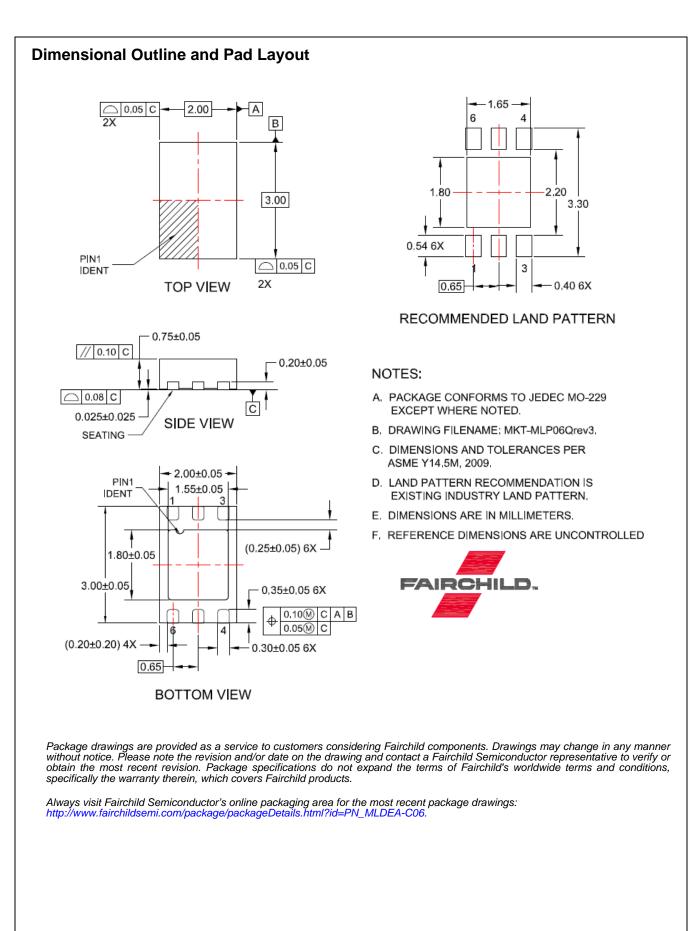


FDMB2307NZ Rev.C7

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FDMB2307NZ Dual Common Drain N-Channel PowerTrench<sup>®</sup> MOSFET







No Identification Needed

Obsolete

**Full Production** 

Not In Production

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